rfmd.com

RF2815

GPS LOW NOISE AMPLIFIER WITH INTEGRATED OUTPUT SAW FILTER

Package: Module, 3.3x2.1x1.0



Features

Low Noise Figure: 0.85dB (Typ.)

High Gain: 13.5dBHigh IIP3: +9dBm

Operable Over Wide Supply Voltage Range: 1V to 3.6V

CMOS Compatible Shutdown Function (<0.1uA)

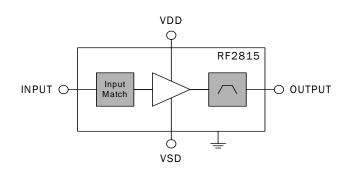
 Current Tunability Via Single Resistor

 No External DC-Blocking Capacitor Required at the Output - Lowest BOM Cost and Small Solution Size

■ Compact Footprint: 3.3mmx2.1mmx1.0mm

Applications

 Cellular and Non-Cellular GPS Receivers



Functional Block Diagram

Product Description

The RF2815 is a GPS Low Noise Amplifier with an integrated SAW filter at the output. Low noise figure, along with high gain, achieved by the RF2815 makes it ideal for GPS recievers requiring high sensitivity. This module builds upon RFMD's leading edge pHEMT process and integrates input matching and low loss high rejection SAW filter at the output. This results in high performance and a reduced solution size. The ease of implementation simplifies the reciever design.

The RF2185 is packaged in a compact 3.3mmx2.1mmx1.0mm package with low external component count required to achieve the best-in-class performance.

Ordering Information

RF2815 GPS Low Noise Amplifier with Integrated Output SAW Filter RF2815PCBA-410 Fully Assembled Evaluation Board

Optimum Technology Matching® Applied

☐ GaAs HBT	☐ SiGe BiCMOS	▼ GaAs pHEMT	☐ GaN HEMT
☐ GaAs MESFET	☐ Si BiCMOS	☐ Si CMOS	☐ RF MEMS
☐ InGaP HBT	☐ SiGe HBT	☐ Si BJT	☐ LDMOS

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Absolute Maximum Ratings

Parameter	Rating	Unit
V _{DD}	3.6	V
I _{DD}	20	mA
Maximum Input Power - CW, V _{DD} =2.85V, I _{DD} =9mA	+15	dBm
P _{DISS}	72	mW
Max Voltage on RF Output (Pin 8)	+5	V
T _J (Junction Temperature)	150	°C
Storage Temperature	-65 to +150	°C
Operating Temperature	-40 to +85	°C



Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

RoHS status based on EUDirective 2002/95/EC (at time of this document revision).

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Davamatav	Specification		11:4	Condition		
Parameter	Min.	Тур.	Max.	Unit	Condition	
High Current Mode					$\begin{split} &V_{DD}\!=\!+2.85, \text{VSD}\!=\!2.6\text{V}, \text{I}_{DD}\!=\!8\text{mA}, \text{R2}\!=\!3\text{k}\Omega., \\ &\text{Freq}\!=\!1575.42\text{MHz}. \text{Nominal Operating Conditions (unless otherwise specified)} \end{split}$	
Gain (G)	11	13.5		dB		
Noise Figure (NF)*		0.85	1.3	dB		
Input P1dB Compressed Power (P1dB)		-2		dBm		
Input 3rd Order Intercept Point (2-tone @ fc±2.5 Hz)		9		dBm		
Input Return Loss (S11)		-8		dB		
Output Return Loss (S22)		-13		dB		
Reverse Isolation (S12)		-24		dB		
Cell Band Rejection (Relative to 1575 GHz at 827.5 Hz	50	54		dBc		
PCS Band Rejection (Relative to 1575 GHz at 1885 MHz)	39	42		dBc		
Supply DC Current at Shutdown (SD) Voltage VSD=2.6V (I _{DD})		8	15	mA		
ISH (Shutdown Current)		0.1		uA		
Low Current Mode					V_{DD} =+2.85, VSD=1.67V, I_{DD} =4.5mA, R2=3k Ω . Freq=1575.42MHz. Nominal Operating Conditions (unless otherwise specified)	
Gain (G)		12		dB		
Noise Figure (NF)*		1		dB		
Input P1dB Compressed Power (P1dB)		0		dBm		
Input 3rd Order Intercept Point (2-tone @ fc±2.5 Hz)		7		dBm		
Input Return Loss (S11)		-7		dB		
Output Return Loss (S22)		-11		dB		
Reverse Isolation (S12)		-24		dB		
Cell Band Rejection (Relative to 1575 GHz at 827.5 Hz	50	55		dBc		
PCS Band Rejection (Relative to 1575 GHz at 1885 MHz)	39	42		dBc		





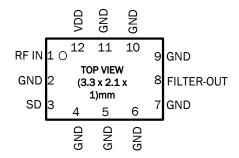
Parameter	Specification		Hoit	Condition	
raiaillelei	Min.	Тур.	Max.	Unit	Condition
Low Current Mode (cont.)					V_{DD} =+2.85, VSD=1.67 V, I_{DD} =4.5 mA, R2=3 kΩ. Freq=1575.42 MHz. Nominal Operating Conditions (unless otherwise specified)
Supply DC Current at Shutdown (SD) Voltage VSD=1.67 V (I _{DD})		4.5		mA	
ISH (Shutdown Current)		0.1		uA	
Low Operating Voltages	VDD=2V	VDD=1.5V	VDD=1V		VDD=VSD, R2=1.5K. Freq=1575.42MHz. Nominal Operating Conditions (unless otherwise specified).
Gain (G)	14	12.5	11.5	dB	
Noise Figure (NF)*	0.85	0.95	1.1	dB	
Input P1dB Compressed Power (P1dB)	-2	-4	-6	dBm	
Input 3rd Order Intercept Point (2-tone @ fc±2.5 Hz)	10	7.5	3	dBm	
Input Return Loss (S11)	-9	-8	-7	dB	
Output Return Loss (S22)	-13.5	-12.5	-11	dB	
Reverse Isolation (S12)	-24	-24	-22	dB	
Cell Band Rejection (Relative to 1575 GHz at 827.5 Hz	52	52	52	dBc	
PCS Band Rejection (Relative to 1575 GHz at 1885 MHz)	42	42	42	dBc	
Supply DC Current at Shutdown (SD) Voltage VSD=2.85V (I _{DD})	10.5	7.3	4	mA	
ISH (Shutdown Current)	0.1	0.1	0.1	uA	

Notes: *Noise Figure data has not been de-embedded.

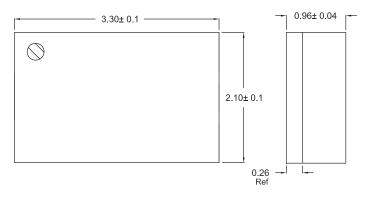


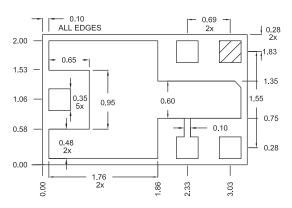
Pin	Function	Description
1	RF IN	RF input.
2	GND	Ground.
3	SD	Shutdown.
4	GND	Ground.
5	GND	Ground.
6	GND	Ground.
7	GND	Ground.
8	FILTER OUT	RF output.
9	GND	Ground.
10	GND	Ground.
11	GND	Ground.
12	VDD	Supply.

Pin Out



Package Drawing



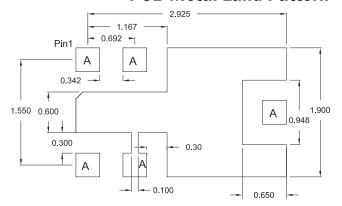


NOTES:

1. SHADED AREAS REPRESENT PIN 1 LOCATION.

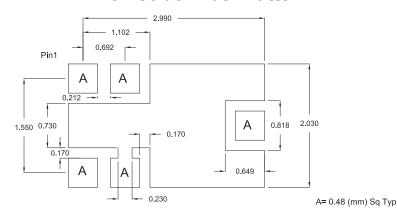


PCB Metal Land Pattern

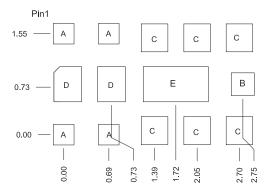


A= 0.35 (mm) Sq Typ

PCB Solder Mask Pattern



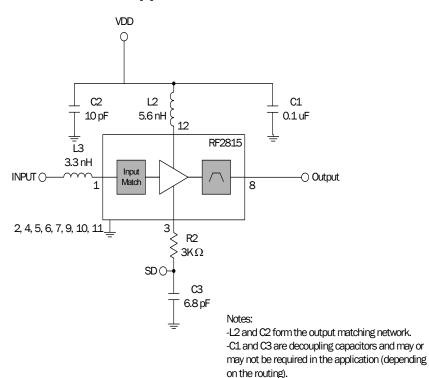
PCB Stencil Pattern



A= 0.31 (mm) Sq Typ B= 0.35 (mm) Sq Typ C= 0.41 (mm) Sq Typ D= 0.42 x 0.54 (mm) Typ E= 1.00 x 0.54 (mm)



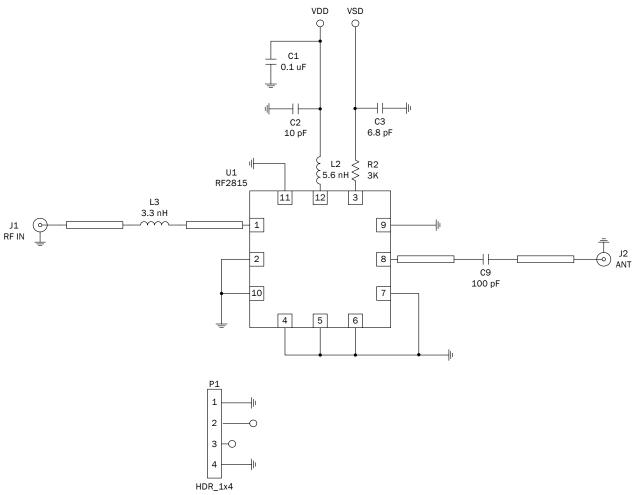
Application Schematic



-L3 forms the input match.



Evaluation Board Schematic



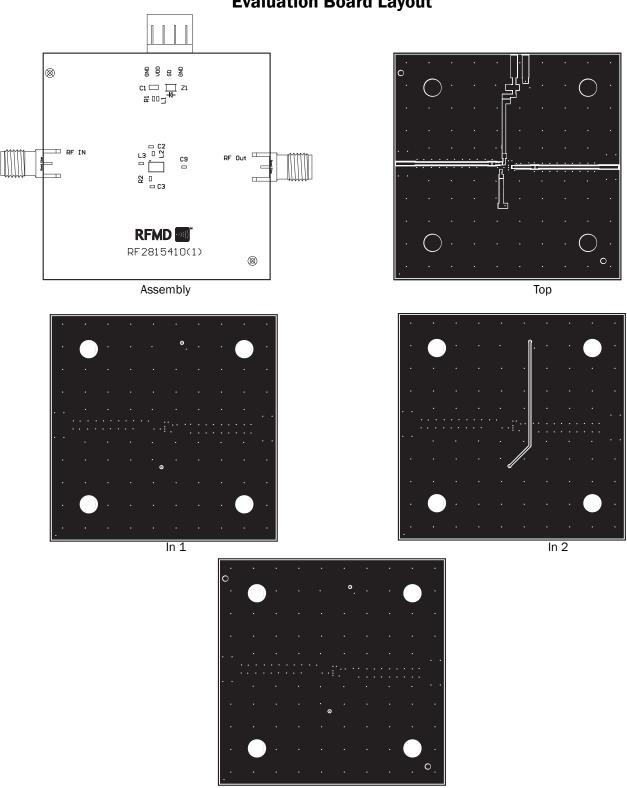
BOM (for Eval Board)

Ref Designator	Value
L2	5.6nH inductor
L3	3.3 nH inductor
C1	0.1uF capacitor
C2	10 pF capacitor
C3	6.8pF capacitor
R2	3K
C9	100 pF

Note: C9 is not needed in the actual application as RF2815 has an integrated DC Blocking capacitor at the output.



Evaluation Board Layout

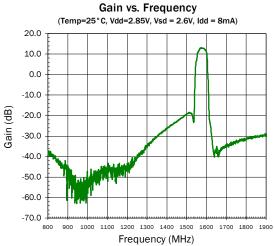


Back

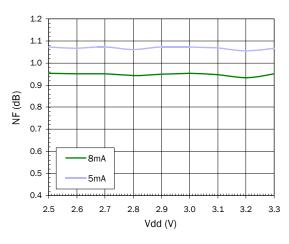


Typical Performance Data on Evaluation Board

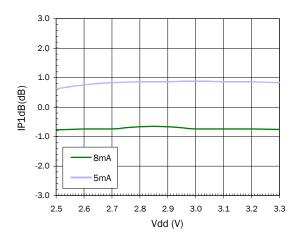
Fixture losses have not been de-embedded (Temp=25 °C, V_{DD} =2.85 V, R2=3 k Ω)



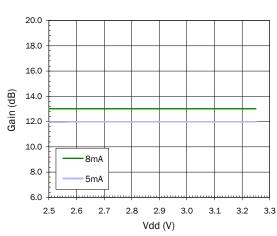
NF vs. Vdd vs. Idd



IP1dB vs. Vdd vs. Idd



Gain vs. Vdd vs. Idd



IIP3 vs. Vdd vs. Idd

